

## **Product Information**

www.miller-stephenson.com

## **ReleaSys™ Product Guide**

## Semi-Permanent Mold Release

## ReleaSys™ Benefits:

- Cost-Effective, Efficient Release
- Superior Durability and Surface Adhesion
- Multiple Releases Per Application
- Various Slip Levels; Minimal Transfer to Molded Product
- Low Odor; Nonflammable Formulations

	Release Type	Carrier Solvent	Application Specifics	Compound Compatibility	Finish	Cure Temp/ Time	Max Operating Temperature
ReleaSys™ 8200	Semi- Permanent (Fluoro- polymer)	Water	Ideal for Silicone containing compounds. Compression Transfer	Fluorosilicones, Nitrile, SBR, Natural and Synthetic Rubber, Chlorinated Polyethylenebutadiene	Matte	132°C (270°F) for 3 mins	327°C (620°F)
ReleaSys™ 8500	Semi- Permanent (Thermoset Polysiloxane)	Water	General Purpose, low complexity molds: Injection, transfer	Fluoroelastomers, EPDM, Butyl, Ethylene Acrylics, Plastics (Urethane, ABS)	Matte	132°C (270°F) for 3 mins	200°C ( 392°F)
ReleaSys™ 8800	Semi- Permanent (Thermoset Polysiloxane)	Water	Intricate mold geometries, Highest Slip. Compression Transfer, RIM Injection	Organic Polymers, Fluoroelastomers, EPDM, Organic and Synthetic Rubber, Plastics, Extrusion PU, Neoprene	Matte	132°C (270°F) for 3 mins	200°C ( 392°F)
ReleaSys™ 8900	Semi- Permanent (Thermoset Polysiloxane)	Solvent	Complex mold geometries, Highest Slip. Compression Transfer, RIM Injection, Mandrel Overlay	Composites, Urethanes, Elastomers, Plastics, Fluoroelastomers	Matte	>80 °C (176°F) for 1-3 mins	200°C ( 392°F)